

150X Ø0.39±0.05
PLATED THRU HOLE

150X Ø0.48±0.013
DRILL HOLE

⊕ Ø0.10

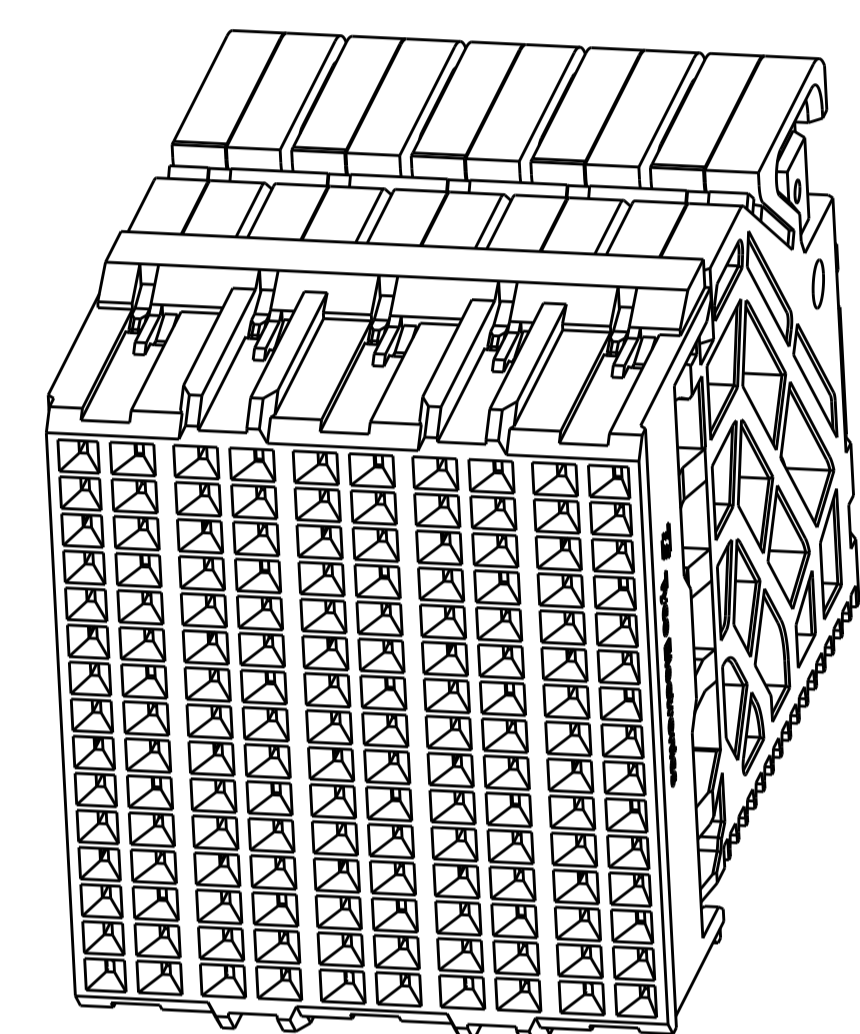
OFFSET BETWEEN BOARD AND
BACKPLANE HOLE COLUMNS

RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

LOC	DIST	REVISIONS			
AD	00	REV	DATE	BY	APPV
		D	10APR2015	AP	DD

⚠ MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.

⚠ FINISH:
30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN
ON PCB TAILS, NICKEL OVERALL.



SCALE 4:1

REFER TO WWW.TE.COM
FOR PRODUCT AVAILABILITY

NONE	⚠	2132695-1
KEY POSITION	FINISH	PART NUMBER
TE TE Connectivity		
DIMENSIONS: mm TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ± 1 PLC ±0.25 2 PLC ±0.15 3 PLC ± 4 PLC ± ANGLES ±		DWN: 29APR2011 CHK: D. DIXON 29APR2011 APVD: D. DIXON 29APR2011 PRODUCT SPEC APPLICATION SPEC WEIGHT CUSTOMER DRAWING
MATERIAL: SEE TABLE		NAME: IMPACT, ORTHOGONAL, 5 PAIR, DAUGHTERCARD, 10 COLUMN, NO GUIDE, SIGNAL MODULE, 0.39 EYELET SIZE: A1 CAGE CODE: 00779 DRAWING NO: 2132695 RESTRICTED TO:
SCALE 6:1		SHEET 1 OF 1 REV D

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